

ADC CALIBRATION TO ACCOMMODATE TEMPERATURE VARIATION USING VERTICAL BLANKING INTERRUPTS

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TECHNICAL FIELD

[0001] The invention relates to display devices. More specifically, the invention relates to calibration of analog to digital converters used in digital displays.

BACKGROUND

[0002] Figure 1 illustrates a broad schematic of an arrangement to generate images and to display the images digital form. In particular, a host 102 (for example, a personal computer) generates an image in digital format. Digital to analog converter (DAC) circuitry 104 associated with the host 102 converts the digital image data generated by the host 102 into analog image data (typically, in RGB format) to be sent out over a connection 106 to digital display circuitry 108. Analog to digital converter (ADC) circuitry 110 associated with the digital display circuitry 108 converts the analog image data back into digital image data, which is then provided to a display 112 such as a liquid crystal (LCD). The operation of the digital display circuitry 108 is typically under the control of a processor (not shown) that is either "on-board" (or otherwise relatively tightly coupled to the circuitry of the digital display circuitry 108) or "off board" (or otherwise less tightly coupled to the circuitry of the digital display circuitry 108).

[0003] With particular respect to the ADC circuitry 110, variation in silicon process may result in internal offset voltages of the ADC circuitry 110 varying with temperature. As a result, when temperature varies, the RGB output data through the ADC circuitry 110 may show data drift.

[0004] The internal offset voltages depend on factors such as threshold voltage mismatch, overdrive voltage and transistor mismatches. The internal offset voltages are cancelled out depending on the values of OFFSET1 and OFFSET2 registers for each of the RGB colors, associated with the ADC circuitry 110. The OFFSET1 and OFFSET2 registers both have the same general effect, but the OFFSET1 register provides a relatively gross adjustment, while the OFFSET2 register provides a relatively finer adjustment. In one example, each one bit adjustment of the OFFSET1 register provides 1.7 bits of least significant bit (LSB) adjustment to the ADC circuitry 110 for a color channel, while each one bit adjustment of the OFFSET2 register provides 0.8 bits of LSB adjustment to the ADC circuitry 110 for the color channel. By appropriately setting the values in the OFFSET1 and OFFSET2 registers for each channel, the result is that the colors (RGB) will be balanced as a whole.

[0005] However, the terms in the equation for determining the offset values for the OFFSET1 and OFFSET2 registers have different temperature coefficients. It is thus difficult to predetermine how to vary these values with temperature change to achieve a perfect cancellation of these different temperature variations. Also, the temperature dependence varies with process, making it even more difficult to predetermine how to correlate the offset values to temperature.

[0006] Conventionally, offset values and gain values are initialized at the power up of the digital display circuitry 108 (including the ADC circuitry 110) and stored in a non-volatile RAM (NVRAM). Thus, color balance is achieved, at least initially.

However, the output data from one or more channels of the ADC circuitry 110 may shift based on changes in operating conditions, such as changes in operating temperature.

[0007] It is thus desirable to respond to such changes in operating conditions and, in particular, to respond in a way that is not nominally visible to a typical viewer of images on the display 112.

SUMMARY

[0008] In digital display circuitry, configured to display an image encoded in an analog display signal, the digital display circuitry includes analog-to-digital converter (ADC) circuitry to recover pixel data elements of the image. During vertical blanking intervals of the analog display signal, the ADC circuitry is calibrated. Outside the vertical blanking intervals, the ADC circuitry is used to convert information in the analog display signal into digital representations of the pixel data elements. For example, the calibrating may include determining more acceptable values for certain ones of the operational parameters of the ADC circuitry.

BRIEF DESCRIPTION OF THE FIGURES

[0009] Figure 1 is a broad schematic illustration of circuitry to generate images and to display the images in digital form.

[0010] Figure 2 broadly illustrates processing to operate the Figure 1 circuitry to account for changes in operating conditions of the ADC circuitry 110.

[0011] Figure 3 is a flowchart illustrating initialization processing relative to the ADC calibration processing shown in Figure 2.

[0012] Figure 4 is a flowchart illustrating the ADC calibration processing shown in Figure 2.

DETAILED DESCRIPTION

[0013] In general, a method is described to operate digital display circuitry such that the ADC circuitry 110 of the Figure 1 digital display circuitry 108 is calibrated during vertical blanking intervals of the analog display signal sent over connection 106.

[0014] For example, with reference to Figure 2, it can be seen that step 202 (which is outside the vertical blanking interval, or VBI) includes processing to display an image on display 112. The step 202 processing may be entirely conventional. Steps 204 and 206 are during the VBI. At step 206, processing occurs to adjust the operation of the ADC circuitry 110 for changes in operating conditions. At step 204, nominal (e.g., conventional) VBI processing occurs. Thereafter, processing returns to step 202.

[0015] Figure 3 is a flowchart illustrating an example of the ADC calibration processing 206, using an internal DAC as input to the ADC circuitry 110. By using the internal DAC as input for the ADC circuitry 110 during calibration, extraneous influences can be minimized or eliminated. For example, interferences such as change of amplitude and external analog noise from the external ADC circuitry 110 inputs can be minimized or eliminated.

[0016] Turning now to Figure 3, reference numeral 300 merely indicates an entry point into the Figure 3 processing. At step 302, the internal DAC enabled as input to the ADC circuitry 110. The output of the internal DAC is programmed to ADC_TEST_DACVALUE (a user-programmable parameter to the processing). Also, the ADC circuitry 110 bandwidth is set to zero, which eliminates high frequency band interference.

[0017] At step 304, the ADC Data registers (output) are read. In the illustrated example, each ADC Data register is read multiple times. As discussed immediately below, this provides an opportunity for better ensuring the quality of the read ADC output data.

[0018] For example, in some examples, apparently aberrant output values of the ADC circuitry 110 are discarded. In a particular example, if values in adjacent (in time) readings of a particular ADC Data register is greater than ADC_GLITCH_THRESHOLD, then the values are not considered in the ADC calibration processing.

[0019] Furthermore, as shown at step 306, a moving average of the ADC output data is determined, and this moving average is used as input to the ADC calibration processing. By using the moving average, slow moving random noise exhibited in the ADC output data can be "averaged out." In a particular implementation of moving average processing, each ADC Data register is read OFFSET_ARRAY times, an average value is determined from the OFFSET_ARRAY read values, and then this average value is rounded to the nearest integer.

[0020] At step 308, the rounded, averaged value that is the result of step 306 is compared to a previously-saved result of step 306 (i.e., from a previous execution of the Figure 3 ADC Calibration processing, in a previous VBI). If the difference between the current step 306 result and the previous step 306 result exceed ADC_THRESHOLD, then processing goes to step 310. At step 310, the new ADC data is saved and the OFFSET2 value is adjusted.

[0021] In one example, the processing at step 310 is such that the OFFSET2 value is adjusted only slightly (e.g., by one bit) each time the Figure 3 processing is executed. In this example, if further adjusting of the OFFSET2 value is required to bring the ADC circuitry 110 to calibration, then the further adjusting would occur naturally as a result of subsequent executions of the Figure 3 processing, on subsequent VBI's.

[0022] At step 312, the operational GAIN value is restored to the ADC circuitry 110 in place of the zero GAIN value used during Figure 3 calibration processing. Then ADC calibration processing exits at step 314.

[0023] If the difference between the current step 306 result and the previous step 306 result do not exceed ADC_THRESHOLD, then the OFFSET2 value is not adjusted. Processing then continues at step 312 to restore the operational GAIN value, and the ADC calibration processing exits at step 314.

[0024] We now turn to Figure 4, which is a flowchart illustrating initialization processing for the ADC calibration of Figure 3. Portions of the Figure 4 processing are the same as processing of Figure 3, and these same portions are denoted by identical reference numerals. The Figure 4 processing is typically executed upon power up of the digital display circuitry 108, and may be executed at other times as appropriate, such as when called by an on-screen display setup function.

[0025] Reference numeral 400 merely indicates an entry point into the Figure 4 processing. At step 402, it is determined whether the ADC circuitry 110 has been

previously calibrated and the determined ADC OFFSET1 value has been stored into NVRAM. If so, then processing at step 404 executes to perform missing code calibration. Missing code calibration handles the case where there is an apparent discontinuity in the output function of the ADC circuitry 110.

[0026] For example, the ADC output function may be such that there are 255 different output digital codes, in steps of one, if the input is varied by one. Sometimes, due to internal ADC characteristics, there may not be a true one-to-one correspondence between the input and the output of the ADC circuitry 110. In missing code calibration, the input code at which the discontinuities occur are remembered, as well as the "fix" for the discontinuity. Then, in operation of the ADC circuitry 110, when such an input code is detected, the appropriate offset adjustments are made. For example, if an output code of sixty four was expected based on the input, and sixty five is seen at the output, then the next time an input code of sixty four is detected, one is subtracted from the output, to calibrate for the missing code.

[0027] If the ADC circuitry 110 has not been previously calibrated and the determined ADC OFFSET1 value stored into NVRAM, then processing at step 408 executes to calibrate the ADC circuitry 110 to determine a suitable OFFSET1 value. By performing the OFFSET1 calibration multiple times and averaging (i.e., referring to Figure 4, AUTO_ADC_INIT_AVG times), there is a greater probability of minimizing the effect of glitches or other wrong values being recorded and stored into NVRAM. At step 410, the averaged OFFSET1 value is rounded to the nearest integer and stored into NVRAM.

[0028] At step 302 (like in Figure 3), the DAC is enabled and programmed to output a desired test output value as input the ADC circuitry 110. At step 412, new OFFSET2 and GAIN values are calculated for each color channel of the ADC circuitry 110.

[0029] At step 304, the ADC data registers are read, accounting for the potential of glitches in the reading, as in the Figure 3 processing. At step 306 the data values are averaged, as in the Figure 3 processing. Finally, at step 414, the new ADC DATA and OFFSET2 values are stored, to be used as initial values in subsequent Figure 3 processing during VBI intervals.

[0030] In accordance with some examples, there are events of higher priority than ADC calibration that should be serviced during VBI's. One such event is communication of data between the digital display circuitry 108 and the host device

102. When such events are detected, in some examples, ADC calibration is not performed for at least a predetermined number of VBI's. In one particular example, this is implemented by initializing a HOLDOFF counter upon detection of the higher priority event, decrementing the HOLDOFF counter at each VBI, and discontinuing ADC calibration processing until the HOLDOFF counter has reached zero.

[0031] In addition, in some examples, the Figure 3 processing will take more than the amount of time that is available for such processing during a VBI. In this case, the Figure 3 processing is made re-entrant, e.g., by utilizing a timer interrupt to save the state of the Figure 3 processing on an alternate stack between VBI's, and the Figure 3 processing is carried out over multiple VBI's.

What is claimed is:

1. In digital display circuitry, configured to display an image encoded in an analog display signal, the digital display circuitry including analog-to-digital converter (ADC) circuitry to recover pixel data elements of the image, a method comprising:

during vertical blanking intervals of the analog display signal, calibrating the ADC circuitry; and

outside the vertical blanking intervals, using the ADC circuitry to convert information in the analog display signal into digital representations of the pixel data elements.

2. The method of claim 1, wherein:

the calibrating step includes determining more acceptable values for certain ones of the operational parameters of the ADC circuitry.

3. The method of claim 2, wherein the calibrating step includes:

providing a predetermined test input value to the ADC circuitry; and

receiving at least one output value of the ADC circuitry for the test input value to the ADC circuitry and, based thereon, determining the more acceptable values for the certain ones of the operational parameters.

4. The method of claim 3, wherein:

the step of providing a predetermined test input value to the ADC circuitry includes:

enabling digital-to-analog converter (DAC) circuitry of the ADC circuitry;

causing the DAC circuitry to provide the predetermined test input value as an output of the DAC circuitry.

5. The method of any of claims 3-4, wherein:

while receiving the at least one output value, setting the values of operational parameters of the ADC circuitry, other than the certain ones of the operational parameters, to particular test operational values.

6. The method of claim 5, wherein the particular test operational values that are the same for each step of providing the predetermined test input value to the ADC circuitry.

7. The method of claim 6, further comprising:
prior to receiving the at least one output value, changing the operational parameters of the ADC to the predetermined test values.

8. The method of claim 7, further comprising:
prior to termination of the vertical blanking interval, changing the operational parameters of the ADC to be other than the predetermined test values.

9. The method of any of claims 3-8, wherein:
determining the more acceptable operational parameters includes comparing the at least one output value of the ADC circuitry to an indication of previously-obtained output values of the ADC circuitry; and
based on a result of the comparing, determining the more acceptable values for the certain one of the operational parameters.

10. The method of claim 9, wherein:
the at least one output value includes a plurality of output values for a same test input value;
the method further comprises determining a representative output value based on the plurality of output values; and
in the comparing step, the representative output value is used to indicate the plurality of output values.

11. The method of claim 10, wherein:

determining the representative output value based on the plurality of output values includes determining an average of the plurality of output values.

11. The method of claim 10, wherein:

the step of determining the average of the plurality of output values includes:

first determining if any of the plurality of output values appear to be aberrant; and

disregarding the aberrant values when determining the average.

12. The method of claim 11, wherein:

the step of determining if any of the plurality of output values appear to be aberrant includes, for each of the plurality of output values,

comparing that one of the plurality of output values to at least one other of the plurality of output values; and

determining that one of the plurality of output values is aberrant based on a result of the comparing step.

13. The method of any of claims 1-12, wherein:

a single step of calibrating the ADC circuitry is executed in one vertical blanking interval.

14. The method of any of claims 1-12, wherein:

a single step of calibrating the ADC circuitry is executed in greater than one vertical blanking interval.

15. The method of claim 14, further comprising:

controlling the calibrating step to execute in greater than one vertical blanking interval.

16. The method of claim 15, wherein:

the step of controlling the calibrating step to execute in greater than one vertical blanking interval includes,

determining, at a particular vertical blanking interval, whether to initiate the calibrating controlling step of whether to continue executing a previously initiated calibrating controlling step.

17. The method of any of claims 1-12, further comprising:
during the vertical blanking intervals, limiting the time during which the calibrating step is executed.

18. The method of claim 17, wherein:
the step of limiting the time during which the calibrating step is executed during a particular vertical blanking interval is responsive to a timer interrupt.

19. The method of claim 18, wherein:
executing of a calibrating step is terminated during a particular vertical blanking interval based on occurrence of the timer interrupt.

20. The method of any of claims 1-19, wherein:
based on an indication of higher priority processing, not executing processing of the calibrating step during particular vertical blanking intervals.

21. The method of claim 20, wherein:
the a number of vertical blanking intervals during which processing of the calibrating step is not executed is predetermined to be at least a particular number of consecutive vertical blanking intervals.

22. The method of claim 20, wherein:
the higher priority processing is communication of data between the digital display circuitry and a host device.

23. The method of any of claims 2-20, wherein:
determining the more acceptable values for the certain ones of the operational parameters includes determining values for which, if the certain ones of the

operational parameters are adjusted thereto, the change in the image displayed by the digital display circuitry will be below a particular threshold.

24. The method of claim 23, further comprising:
initially determining the particular threshold.

25. The method of claim 24, wherein:
initially determining the particular threshold includes considering nominal properties of human vision.

26. The method of any of claims 1-25, further comprising:
Not executing the calibrating step for a predetermined period after power up of the digital display circuitry.

27. The method of any of claims 1-26, wherein calibrating the ADC circuitry is to account for changes in internal offset voltage of the ADC circuitry.

28. The method of claim 27, wherein the calibrating step includes determining more acceptable values for certain ones of the operational parameters of the ADC circuitry, wherein the certain ones of the operational parameters include adjustments to the internal offset voltages.

ABSTRACT

ADC CALIBRATION TO ACCOMMODATE TEMPERATURE VARIATION USING VERTICAL BLANKING INTERRUPTS

In digital display circuitry, configured to display an image encoded in an analog display signal, the digital display circuitry includes analog-to-digital converter (ADC) circuitry to recover pixel data elements of the image. During vertical blanking intervals of the analog display signal, the ADC circuitry is calibrated. Outside the vertical blanking intervals, the ADC circuitry is used to convert information in the analog display signal into digital representations of the pixel data elements. For example, the calibrating may include determining more acceptable values for certain ones of the operational parameters of the ADC circuitry.

Fig. 2